

Notice for TAIYO YUDEN Products

Please read this notice before using the TAIYO YUDEN products.

? REMINDERS

Product Information in this Catalog

Product information in this catalog is as of March 2023. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for general-purpose and standard use in general electronic equipment for consumer (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets, or the equipment approved separately by TAIYO YUDEN.

TAIYO YUDEN has the product series intended for use in the following equipment. Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

Application	Product Series	Quality Grade*3		
Application	Equipment *1 Category (Part Number Code *2)		Quality Clade	
Automotive	Automotive Electronic Equipment (POWERTRAIN, SAFETY)		1	
Adtornotive	Automotive Electronic Equipment (BODY & CHASSIS, INFOTAINMENT)	С	2	
Industrial	Telecommunications Infrastructure and Industrial Equipment	В	2	
Medical Devices classified as GHTF Class C (Japan Class III)		M	2	
iviedicai	Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)	L	3	
Consumer	General Electronic Equipment S		3	
Consumer	Only for Mobile Devices *4	E	4	

^{*}Notes:1. Based on the general specifications required for electronic components for such equipment, which are recognized by TAIYO YUDEN, the use of each product series for the equipment is recommended. Please be sure to contact TAIYO YUDEN before using our products for equipment other than those covered by the product series.

^{2.} On each of our part number, the 2nd code from the left is a code indicating the "Category" as shown in the above table. For details, please check the explanatory materials regarding the part numbering system of each of our products.

^{3.} Each product series is assigned a "Quality Grade" from 1 to 4 in order of higher quality. Please do not incorporate a product into any equipment with a higher Quality Grade than the Quality Grade of such product without the prior written consent of TAIYO YUDEN.

^{4.} The applications covered by this product series are limited to mobile devices (smartphone, tablet PC, smartwatch, handheld game console, etc.) among general electronic equipment for consumer. The design, specifications and operating environment, etc. differ from those of the product series for "General Electronic Equipment" (Category: S), so please check the individual product specification sheets for details. The product series for "General Electronic Equipment" (Category: S) can also be used for mobile devices.

[▶] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/).

2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, data-processing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment *1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices *2
- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, etc.)
- (6) Military equipment
- (7) Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above
- *Notes:1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
 - 2. Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves conforming to the product specifications specified in the individual product specification sheets, and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement, provided, however, that our products shall be used for general-purpose and standard use in the equipment specified in this catalog or the individual product specification sheets.

■ TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

2023

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Medical Application Guide

According to the medical devices classified as GHTF Classes A to C (Japan Classes I to III), we have the corresponding product series (the 2nd code from the left side of the part number is "M" or "L") intended for use in the medical devices. Therefore, when using our products for the medical devices, please be sure to check the classification based on the GHTF Rules and use the corresponding product series.

On the other hand, we don't have the product series intended for use in (i) all medical devices classified as GHTF Class D (Japan Class IV) and (ii) implantable medical devices (bone-anchored hearing aid, artificial retina system, and external unit which is connected to internal unit which is implanted in a body, etc.). Therefore, please do not incorporate our products into these medical devices. Should you have any questions on this matter, please contact us.

Risk I	Level	Low					High
		Class I General Medical Devices (GHTF Class A)	Med	Class II Controlled dical Devices HTF Class B)	Class III Specially-cont Medical Devi (GHTF Class	rolled ices	Class IV Specially-controlled Medical Devices (GHTF Class D)
	y to n les)	Medical devices with extremely low risk to the human body in case of problems	relativel	devices with y low risk to the body in case of is	Medical devices relatively high ris human body in c problems	k to the	Medical devices highly invasive to patients and with life-threatening risk in case of problems
Japan	Classification according to the PMD Act of Japan (based on the GHTF Rules)	problems [Ex.] In Vitro Diagnostic Devices Nebulizer Blood Gas Analyzer Plethysmographs Breathing Sensor AC-powered Operating Table Surgical Light Cholesterol Analysis Device Blood Type Analysis Device, etc.		[Ex.] • Electronic Thermometer • Electronic Blood Pressure Gauge • Electronic Endoscope • Hearing Aid • Electrocardiograph • MRI • Ultrasonic Diagnostic System • Diagnostic Imaging Equipment • X-ray Diagnostic Equipment • Central Monitor • Pulse Oximeter, etc.		[Ex.] Cardiac Pacemaker Video Flexible Angioscope Implantable Infusion Pump Cardiac Electrosurgical Unit Inspection Device with Cardiac Catheter Defibrillator, etc.	
	ation			General C	0 0,111 010 01110		Class III General Controls and Premarket Approval
U.S.A.	FDA Classification	Medical devices without to possibility of causing serical injury or harm to the patienuser even if there is a definal function in such medical devices	ous ent or ect or	Medical devices possibility of cau harm to the patie there is a defect in such medical	sing injury or ent or user if or malfunction	possib injury, patien malfun	al devices with the ility of causing serious disability or death to the or user if a defect or ction occurs in such al devices
Corresponding TAIYO YUDEN Product Series		Product Series for classified as GHT (Japan Cla (The 2nd Code from the Numb	F Classo	es A or B	Product Serie Medical Dev classified as (Class C (Japan ((The 2nd Code the Left Side of the Number: "M (See the Note be	ices GHTF Class III) from he Part I")	N/A

^{*} Note: It is prohibited that our products are used in some medical devices such as implantable medical devices even if such medical devices are classified as GHTF Class C (Japan Class III).

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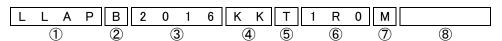
Wire-wound Metal Power Inductors MCOIL™ LLAP series for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)

Code in front of Series have been extracted from Part number, which describes the segment of products, such as kinds and characteristics

REFLOW

* Operating Temp.:-40~+125°C (Including self-generated heat) PART NUMBER

* Operating Temp.:-40~+105°C (Including self-generated heat) %1Parts Number reference



1)Series

Code	
(1)(2)(3)(4)	
LLAP	Wire-wound Metal Power Inductor for Medical Devices classified as GHTF Classes A or B (Japan Classes Lor II)

(1) Product Group

Code	·
L	Inductors

(2) Category

②Features Code

Code	Recommended equipment	Quality Grade
L	Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)	3

Feature

L-shape electrode (Ag-resin × Sn-plate)

(3) Type Code

Code

3 Fackaging					
Code	Packaging				
Т	Taning				

Metal Wire-wound

High current power choke

3Dimensions (L × W)

В

Code	Type (inch)	Dimensions (L×W)[mm]
2016	2016(0806)	2.0 × 1.6
2520	2520(1008)	2.5 × 2.0

(4)Dimensions (T)

& Billicial of 17					
Code	Dimensions (T) [mm]				
KK	1.0				
MK	1.2				

6 Nominal inductance

(4) Features, Characteristics

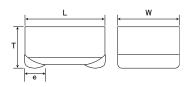
Code (example)	Nominal inductance[μH]
R47	0.47
1R0	1.0
4R7	4.7

7 Inductance tolerance

Code	Inductance tolerance
М	±20%

8Internal code

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns

Surface Mounting

- •Mounting and soldering conditions should be checked beforehand.
- · Applicable soldering process to these products is reflow soldering only.



Type	Α	В	С
2016	0.7	0.8	1.8
2520	0.8	1.2	2.0
			Unit:mm

Туре	L	W	Т	е	Standard quantity[pcs] Taping
2016KK	2.0±0.1 (0.079±0.004)	1.6±0.1 (0.063±0.004)	1.0 max (0.039 max)	0.5±0.3 (0.020±0.012)	3000
2520KK	2.5±0.2 (0.098±0.008)	2.0±0.2 (0.079±0.008)	1.0 max (0.039 max)	0.5±0.3 (0.020±0.012)	3000
2520MK	2.5±0.2 (0.098±0.008)	2.0±0.2 (0.079±0.008)	1.2 max (0.047 max)	0.5±0.3 (0.020±0.012)	3000

Unit:mm(inch)

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PART NUMBER

2016KK type		Thickr	ess:1.0mm max.]						
	Old part number		Nominal inductance		Self-resonant	DC Resistance		※) [mA] (max.)	Measuring frequency[MHz]
New part number	(for reference)	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	[Ω](max.)	Saturation current Idc1	Temperature rise current Idc2	
LLAPB2016KKTR22M	MAKK2016HR22M	RoHS	0.22	±20%	-	0.026	5,800	4,000	2
LLAPB2016KKTR24M	MAKK2016HR24M	RoHS	0.24	±20%	-	0.026	5,800	4,000	2
LLAPB2016KKTR33M	MAKK2016HR33M	RoHS	0.33	±20%	ı	0.030	4,700	3,500	2
LLAPB2016KKTR47M	MAKK2016HR47M	RoHS	0.47	±20%	ı	0.036	4,300	3,300	2
LLAPB2016KKTR68M	MAKK2016HR68M	RoHS	0.68	±20%	ı	0.050	3,200	2,700	2
LLAPB2016KKT1R0M	MAKK2016H1R0M	RoHS	1.0	±20%	ı	0.070	2,700	2,300	2
LLAPB2016KKT1R5M	MAKK2016H1R5M	RoHS	1.5	±20%	-	0.105	2,100	1,800	2

2520KK type		[Thickr	ness:1.0mm max.]						
New part number	Old part number (for reference)	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (max.)	Rated current Saturation current Idc1		Measuring frequency[MHz]
LLAPB2520KKTR22M	MAKK2520HR22M	RoHS	0.22	±20%	-	0.021	7500	4900	2
LLAPB2520KKTR33M	MAKK2520HR33M	RoHS	0.33	±20%	-	0.026	6200	4300	2
LLAPB2520KKTR47M	MAKK2520HR47M	RoHS	0.47	±20%	=	0.029	5700	4000	2
LLAPB2520KKTR68M	MAKK2520HR68M	RoHS	0.68	±20%	-	0.043	4300	3400	2
LLAPB2520KKT1R0M	MAKK2520H1R0M	RoHS	1.0	±20%	-	0.053	3800	3000	2
LLAPB2520KKT1R5M	MAKK2520H1R5M	RoHS	1.5	±20%	-	0.078	3000	2400	2
LLAPB2520KKT2R2M	MAKK2520H2R2M	RoHS	2.2	±20%	-	0.120	2500	1800	2
LLAPB2520KKT100M	MAKK2520H100M ※1	RoHS	10	±20%	-	0.650	1100	750	2

2520MK type		Thickn	ess:1.2mm max.】						
	Old part number		Nominal inductance [μ H]		Self-resonant frequency [MHz] (min.)	DC Resistance	Rated current	※) [mA](max.)	Measuring frequency[MHz]
New part number	(for reference)	EHS		Inductance tolerance		[Ω](max.)	Saturation current Idc1	Temperature rise current Idc2	
LLAPB2520MKTR22M	MAMK2520HR22M	RoHS	0.22	±20%	-	0.021	7500	5000	2
LLAPB2520MKTR33M	MAMK2520HR33M	RoHS	0.33	±20%	-	0.023	6600	4400	2
LLAPB2520MKTR47M	MAMK2520HR47M	RoHS	0.47	±20%	-	0.026	5800	4100	2
LLAPB2520MKTR68M	MAMK2520HR68M	RoHS	0.68	±20%	-	0.036	5100	3500	2
LLAPB2520MKT1R0M	MAMK2520H1R0M	RoHS	1.0	±20%	-	0.045	4300	3100	2
LLAPB2520MKT1R5M	MAMK2520H1R5M	RoHS	1.5	±20%	-	0.065	3300	2600	2
LLAPB2520MKT2R2M	MAMK2520H2R2M	RoHS	2.2	±20%	-	0.090	2800	2200	2

[%]) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C) %) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C. (at 20°C)

^{*)} The rated current value is following either Idc1 or Idc2, which is the lower one.

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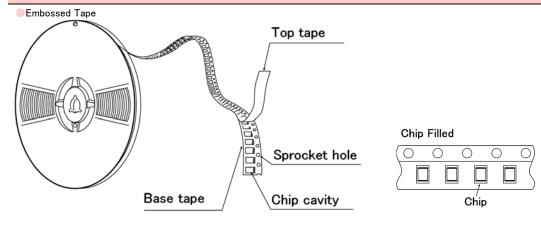
Wire-wound Metal Power Inductors MCOIL[™] LSAN/LLAN series Wire-wound Metal Power Inductors MCOIL[™] LSAP/LLAP series

■PACKAGING

①Minimum Quantity

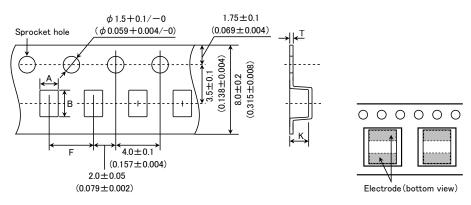
Туре	Standard Quantity [pcs]
	Tape & Reel
2016KK	3000
2520KK	3000
2520MK	3000

2Tape Material



3 Taping dimensions

Embossed tape 8mm wide (0.315 inches wide)

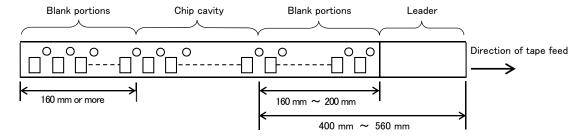


Turna	Chip	cavity	Insertion pitch	Tape th	Tape thickness	
Туре	Α	В	F	T	K	
2016KK	1.9±0.1	2.3±0.1	4.0±0.1	0.25 ± 0.05	1.2 max	
	(0.075±0.004)	(0.091±0.004)	(0.157±0.004)	(0.009±0.002)	(0.047 max)	
2520KK	2.3±0.1	2.8±0.1	4.0±0.1	0.3±0.05	1.25 max	
	(0.091±0.004)	(0.110±0.004)	(0.157±0.004)	(0.012±0.002)	(0.049 max)	
2520MK	2.3±0.1	2.8±0.1	4.0±0.1	0.3±0.05	1.4 max	
	(0.091±0.004)	(0.110±0.004)	(0.157±0.004)	(0.012±0.002)	(0.055 max)	

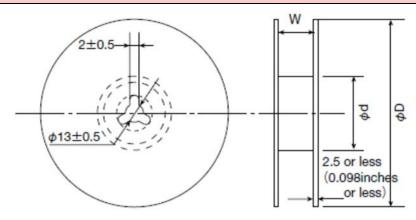
 $\mathsf{Unit}\!:\!\mathsf{mm}(\mathsf{inch})$

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4Leader and Blank portion



⑤Reel size

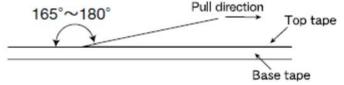


Type	Reel size (Reference values)				
Туре	φD	ϕ d	W		
2016KK	100+0 / 2	60.1/ 0	10.0±1.5		
2520KK	180+0/-3 (7.087+0/-0.118)	60+1/-0 (2.36+0.039/0)	10.0±1.5 (0.394±0.059)		
2520MK	(7.087+0/-0.118)	(2.30+0.039/0)	(0.394±0.039)		

Unit:mm(inch)

©Top Tape Strength

The top The top tape requires a peel-off force of 0.1 to 1.2N in the direction of the arrow as illustrated below.



Wire-wound Metal Power Inductors MCOIL[™] LSAN series for General Electronic Equipment for Consumer Wire-wound Metal Power Inductors MCOIL[™] LSAP series for General Electronic Equipment for Consumer Wire-wound Metal Power Inductors MCOIL[™] LLAN series

for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)

Wire-wound Metal Power Inductors MCOIL[™] LLAP series

for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)

RELIABILITY DATA

1. Operating Temp	erature Range						
operacing remp	-40~+105°C:LSAN/LLAN						
Specified Value	-40~+125°C:LSAP/LLAP						
Test Methods and Remarks	Including self-generated heat						
2. Storage Temper	rature Range						
Specified Value	-40~+85°C						
Test Methods and Remarks	0 to 40°C for the product with taping.						
3. Rated current							
Specified Value	Within the specified tolerance						
	•						
4. Inductance							
Specified Value	Within the specified tolerance						
Test Methods	Measuring equipment : LCR Meter (HP 4285A or equivalent)						
and Remarks	Measuring frequency : 2MHz, 1V						
5. DC Resistance							
Specified Value	Within the specified tolerance						
Test Methods and Remarks	Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent)						
6. Self resonance	frequency						
Specified Value	_						
7. Temperature ch							
Specified Value	Inductance change: Within ±15%						
Test Methods and Remarks	Measurement of inductance shall be taken at temperature range within $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$. With reference to inductance value at $+20^{\circ}\text{C}$., change rate shall be calculated.						
and Remarks	with reference to inductance value at +20 G., change rate shall be calculated.						
8. Resistance to fl	exure of substrate						
Specified Value	No damage						
	The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating						
	until deflection of the test board reaches to 2 mm.						
	Test board size : 100 × 40 × 1.0 mm Force Rod						
Test Methods and Remarks	Test board material : Glass epoxy-resin Solder cream thickness : 0.12 mm						
and nomaino	Board						
	R5 Test Sample 45±2mm 45±2mm						

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9. Insulation resista	nce : betw	een wires					
Specified Value	_						
10. Insulation resist	ance : betv	veen wire and core					
Specified Value	_						
11. Withstanding vo	ltage : betv	veen wire and core					
Specified Value	_						
12. Adhesion of terr	I						
Specified Value	No abnor						
Test Methods and	The test Applied	samples shall be soldered force : 10N		t board by the reflow. ' directions.			
Remarks	Duration		to X and 1	an obtaine.			
	Solder	cream thickness : 0.12	mm.				
13. Resistance to v	1						
Specified Value		ce change : Within ±10% icant abnormality in appea	rance				
	_	samples shall be soldered		t hoard by the reflow			
		hall be submitted to below					
		iency Range 10~5					
Test Methods				exceed acceleration 19 10Hz for 1min.	96m/s²)		
and Remarks	Swee	ping Method 10Hz	.0 33HZ L0	TOPIZ FOR TIMIN.			
		Time		For 2 hours on each	X, Y, and Z axis.		
		Z	L		6		
	Recovery	/ : At least 2hrs of recove	y under the	e standard condition a	fter the test, followed by th	e measurement within 48hrs.	
14. Solderability							
Specified Value	At least	90% of surface of termin	l electrode	is covered by new so	lder		
Opcomed value					en solder as shown in below	table	
Test Methods and		nanol solution containing r		_			
Remarks	Solder Temperature 245±5°C						
	Time XImmer	5±0.5 sec. sersion depth : All sides of mounting terminal shall be immersed.					
	71(2				.		
15. Resistance to s	oldering he	at					
C:::	Inductan	ce change : Within ±10%					
Specified Value	No signif	icant abnormality in appea	rance.				
		sample shall be exposed	to reflow o	oven at 230°C for 40	seconds, with peak temper	vature at $260+0/-5^{\circ}C$ for 5 seconds, 3	
Test Methods	times. Test boa	rd material : Glass e	oxy-resin				
and Remarks		rd thickness : 1.0mm					
	Recovery	/: At least 2hrs of recove	y under th	e standard condition a	fter the test, followed by th	e measurement within 48hrs.	
16. Thermal shock							
Specified Value		ce change : Within ±10% icant abnormality in appea	rance.				
				board by the reflow. T	he test samples shall be pla	ced at specified temperature for specified	
					emperature cycle shall be r		
		Conditions					
Test Methods	Step 1	Temperature (°C) -40±3		Duration (min) 30±3			
and Remarks	2	Room temperature		Within 3			
	3	+85±2		30±3			
	11 /	Room temperature	1	Within 3	İ		

Room temperature

4

Within 3

Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

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17. Damp heat							
Specified Value	_	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.					
T . M .! . !	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.						
Test Methods and Remarks	Temperature	60±2°C					
and Remarks	Humidity	90∼95%RH					
	Time	500+24/-0 hour					
	Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.						

18. Loading under d	amp heat					
Specified Value	Inductance change : Within ±10% No significant abnormality in appearance.					
Test Methods and Remarks	The test samples sh as shown in below to Temperature Humidity Applied current Time	able. 60±2°C 90~95%RH Rated current 500+24/-0 hour	t board by the reflow. cic oven set at specified temperature and humidity and applied the rated current continuously description: e standard condition after the test, followed by the measurement within 48hrs.			

19. Low temperatur	re life test						
Specified Value		nductance change : Within $\pm 10\%$ No significant abnormality in appearance.					
Test Methods	The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table.						
and Remarks	Temperature	-40±2°C					
	Time	500+24/-0 hour					
	Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.						

20. High temperatu	re life test					
Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.					
Test Methods	The test samples s in below table.	hall be soldered to the test	board by the reflow. After that, the test samples shall be placed at test conditions as shown			
and Remarks	Temperature	85±2°C				
	Time	500+24/-0 hour				
	Recovery : At leas	t 2hrs of recovery under th	e standard condition after the test, followed by the measurement within 48hrs.			

Specified Value	
22. Standard cond	ition
Specified Value	Standard test condition : Unless otherwise specified, temperature is $20\pm15^{\circ}$ C and $65\pm20\%$ of relative humidity.
	When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of 20±2°C temperature, 65±5% relative humidity.
	Inductance is in accordance with our measured value.

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Wire-wound Metal Power Inductors MCOIL[™] LSAN/LLAN series Wire-wound Metal Power Inductors MCOIL[™] LSAP/LLAP series

PRECAUTIONS

1. Circuit Design

Precautions

- ◆ Verification of operating environment, electrical rating and performance
 - 1. A malfunction in medical equipment, spacecraft, nuclear reactors, etc. may cause serious harm to human life or have severe social ramifications. As such, any inductors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly differentiated from components used in general purpose applications.
 - 2. When inductors are used in places where dew condensation develops and/or where corrosive gas such as hydrogen sulfide, sulfurous acid, or chlorine exists in the air, characteristic deterioration may occur. Please do not use inductors under such environmental conditions.
- ◆Operating Current (Verification of Rated current)
 - 1. The operating current including inrush current for inductors must always be lower than their rated values.
 - 2. Do not apply current in excess of the rated value because the inductance may be reduced due to the magnetic saturation effect.
- ◆Temperature rise

Temperature rise of power choke coil depends on the installation condition in end products.

Make sure that temperature rise of power choke coils in actual end products is within the specified temperature range.

Precautions A Land pattern design 1. Please refer to a recommended land pattern. Considerations Applicable soldering process to this products is reflow soldering only. Considerations for automatic placement

3. Considerations for automatic placement Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. Technical considerations Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

4. Soldering

Precautions

◆Reflow soldering

1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified.

2. The product shall be used reflow soldering only.

3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering.

◆Lead free soldering

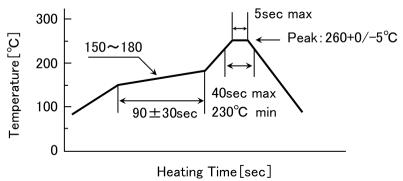
1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently.

◆Reflow soldering

1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

Recommended reflow condition (Pb free solder)





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5. Cleaning		
Precautions	◆Cleaning conditions 1. Washing by supersonic waves shall be avoided.	
Technical considerations	◆Cleaning conditions 1. If washed by supersonic waves, the products might be broken.	

6. Handling	
Precautions	 ◆Handling 1. Keep the product away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆Pick-up pressure 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ◆Packing 1. Please avoid accumulation of a packing box as much as possible.
Technical considerations	 ♦ Handling 1. There is a case that a characteristic varies with magnetic influence. ♦ Breakaway PC boards (splitting along perforations) 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ♦ Mechanical considerations 1. There is a case to be damaged by a mechanical shock. 2. There is a case to be broken by the handling in transportation. ♦ Pick-up pressure 1. Damage and a characteristic can vary with an excessive shock or stress. ♦ Packing 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.

7. Storage conditions		
Precautions	 ♦ Storage To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Storage conditions	
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.	

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